

Semiconductor Equipment Association of Japan

February 2024 Billings (Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note: All data is based on three month average numbers.

Mark your calendars. **The March Report SEAJ's Web site update** is scheduled on 23rd **April** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts February 2024 Billings of ¥317,418 million Tokyo Japan, March 26th, 2024 JAPAN-based manufacturers of semiconductor equipment posted ¥317,418 million in billings in February 2024(three-month average basis) published today by SEAJ.

The billings figure is **0.8% percent up** the final January 2024 level of ¥314,875 million and **7.8 percent up** the 2023 February billings level of ¥294.526 million.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

3/23/1-12 Data revised

	Billings (Three-month avg.) Month-Over-Month		Year-Over-Year		
September 2023revised	299,524	4.1%	-21.4%		
October 2023revised	289,198	-3.4%	-16.7%		
November 2023revised	300,187	3.8%	-10.5%		
December 2023revised	306,412	2.1%	-0.1%		
January 2024(final)	314,875	2.8%	5.0%		
February 2024(prelim)	317,418	0.8%	7.8%		

23/1-8 revised data

Japanese Equipment	23/1	23/2	23/3	23/4	23/5	23/6	23/7	23/8
Billings (3-months)	299,809	294,526	337,042	336,162	315,730	260,913	281,604	287,821
Billing Growth (m/m)	-2.2%	-1.8%	14.4%	-0.3%	-6.1%	-17.4%	7.9%	2.2%
Billing Growth (Y/Y)	-2.1%	0.2%	7.0%	9.8%	2.6%	-8.3%	-12.2%	-17.1%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

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